

NC7SZ18

TinyLogic UHS 1-of-2 Non-Inverting De-multiplexer with 3-STATE Deselected Output

Description

The NC7SZ18 is a 1-of-2 non-inverting demultiplexer. The device will buffer the data on the A pin and pass to either output Y_0 or Y_1 dependent on whether state of the select pin (S) is LOW or HIGH respectively. The deselected output will be placed into a high impedance state. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over the 1.65 V to 5.5 V V_{CC} operating range. The inputs and outputs are high impedance when V_{CC} is 0 V. Inputs tolerate voltages up to 5.5 V independent of V_{CC} operating range.

Features

- Ultra High-Speed: t_{PD} 2.5 ns Typical at 5 V V_{CC}
- High Impedance Output when Deselected
- Broad V_{CC} Operating Range: 1.65 V to 5.50 V
- Power Down High Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



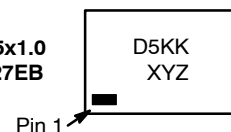
ON Semiconductor®

www.onsemi.com

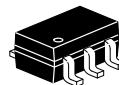
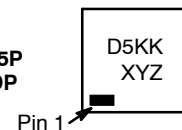
MARKING DIAGRAMS



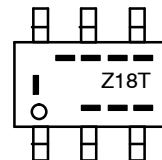
SIP6 1.45x1.0
CASE 127EB



UDFN6
1.0x1.0, 0.35P
CASE 517DP



SC-88
(SC-70 6 Lead)
1.25x2
CASE 419AD-01



D5, Z18	= Specific Device Code
KK	= 2-Digit Lot Run Traceability Code
XY	= 2-Digit Date Code Format
Z	= Assembly Plant Code
----	= Year Coding Scheme
I--	= Plant Code Identifier
T	= Die Run Code
---	= Eight-Week Datacoding Scheme

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

Pin Configurations

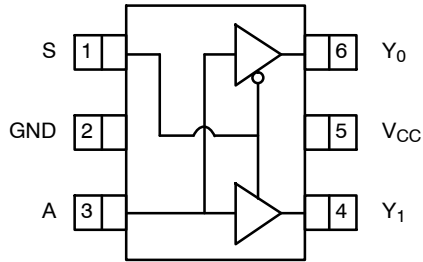


Figure 1. SC70 (Top View)

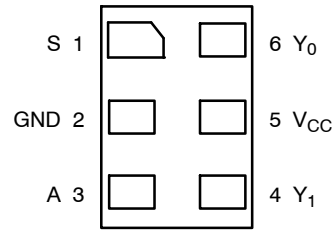
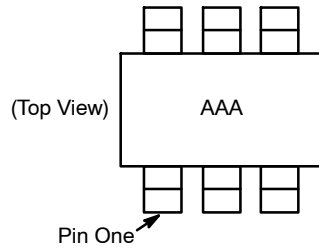


Figure 2. MicroPak (Top Through View)



NOTES:

1. AAA represents product code top mark (see [Ordering Information](#)).
2. Orientation of top mark determines pin one location.
3. Reading the top mark left to right, pin one is the lower left pin.

Figure 3. Pin 1 Orientation

PIN DEFINITIONS

Pin # SC70	Pin # MicroPak	Name	Description
1	1	S	Data Input
2	2	GND	Ground
3	3	A	Demultiplexer Data
4	4	Y ₁	Output
5	5	V _{CC}	Supply Voltage
6	6	Y ₀	Output

FUNCTION TABLE

Inputs		Output	
S	A	Y ₀	Y ₁
L	L	L	Z
L	H	H	Z
H	L	Z	L
H	H	Z	H

H = HIGH Logic Level
L = LOW Logic Level
X = 3-STATE

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V _{CC}	Supply Voltage		−0.5	6.5	V
V _{IN}	DC Input Voltage		−0.5	6.5	V
V _{OUT}	DC Output Voltage		−0.5	6.5	V
I _{IK}	DC Input Diode Current	V _{IN} ≤ −0.5 V	−	−50	mA
I _{OK}	DC Output Diode Current	V _{OUT} ≤ −0.5 V	−	−50	mA
I _{OUT}	DC Output Current		−	±50	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current		−	±100	mA
T _{STG}	Storage Temperature Range		−65	+150	°C
T _J	Junction Temperature Under Bias		−	+150	°C
T _L	Junction Lead Temperature (Soldering, 10 Seconds)		−	+260	°C
P _D	Power Dissipation at +85°C	SC70−6	−	190	mW
		MicroPak−6	−	327	
		MicroPak2™−6	−	327	
ESD	Human Body Model, JEDEC: JESD22−A114		−	4000	V
	Charge Device Model, JEDEC: JESD22−C101		−	2000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage Operating		1.65	5.50	V
	Supply Voltage Data Retention		1.5	5.5	
V _{IN}	Input Voltage		0	5.5	V
V _{OUT}	Output Voltage		0	V _{CC}	V
t _r , t _f	Input Rise and Fall Times	V _{CC} at 1.8 V ±0.15 V, 2.5 V ±0.2 V	0	20	ns/V
		V _{CC} at 3.3 V ±0.3 V	0	10	
		V _{CC} at 5.0 V ±0.5 V	0	5	
T _A	Operating Temperature		−40	+85	°C
θ _{JA}	Thermal Resistance	SC70−6	−	659	°C/W
		MicroPak−6	−	382	
		MicroPak2−6	−	382	°C/W

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

NC7SZ18

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = +25°C			T _A = -40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
V _{IH}	HIGH Level Input Voltage	1.65 to 1.95		0.65 V _{CC}	–	–	0.75 V _{CC}	–	V
		2.30 to 5.50		0.70 V _{CC}	–	–	0.70 V _{CC}	–	
V _{IL}	LOW Level Input Voltage	1.65 to 1.95		–	–	0.25 V _{CC}	–	0.25 V _{CC}	V
		2.30 to 5.50		–	–	0.30 V _{CC}	–	0.30 V _{CC}	
V _{OH}	HIGH Level Output Voltage	1.65	V _{IN} = V _{IH} , I _{OH} = –100 µA	1.55	1.65	–	1.55	–	V
		2.30		2.20	2.30	–	2.20	–	
		3.00		2.90	3.00	–	2.90	–	
		4.50		4.40	4.50	–	4.40	–	
		1.65	I _{OH} = –4 mA	1.29	1.52	–	1.29	–	
		2.30	I _{OH} = –8 mA	1.90	2.15	–	1.90	–	
		3.00	I _{OH} = –16 mA	2.40	2.80	–	2.40	–	
		3.00	I _{OH} = –24 mA	2.30	3.68	–	2.30	–	
		4.50	I _{OH} = –32 mA	3.80	4.20	–	3.80	–	
V _{OL}	LOW Level Output Voltage	1.65	V _{IN} = V _{IL} , I _{OL} = 100 µA	–	0.00	0.10	–	0.10	V
		2.30		–	0.00	0.10	–	0.10	
		3.00		–	0.00	0.10	–	0.10	
		4.50		–	0.00	0.10	–	0.10	
		1.65	I _{OL} = 4 mA	–	0.08	0.24	–	0.24	
		2.30	I _{OL} = 8 mA	–	0.10	0.30	–	0.30	
		3.00	I _{OL} = 16 mA	–	0.15	0.40	–	0.40	
		3.00	I _{OL} = 24 mA	–	0.22	0.55	–	0.55	
		4.50	I _{OL} = 32 mA	–	0.22	0.55	–	0.55	
I _{IN}	Input Leakage Current	1.65 to 5.5	V _{IN} = 5.5 V, GND	–	–	±0.1	–	±1.0	µA
I _{OZ}	3-STATE Output Leakage	1.65 to 5.50	V _{IN} = V _{IL} or V _{OH} , 0 < V _{OUT} ≤ 5.5 V	–	–	±0.5	–	±5.0	µA
I _{OFF}	Power Off Leakage Current	0	V _{IN} or V _{OUT} = 5.5 V	–	–	1	–	10	µA
I _{CC}	Quiescent Supply Current	1.65 to 5.50	V _{IN} = 5.5 V, GND	–	–	1	–	10	µA

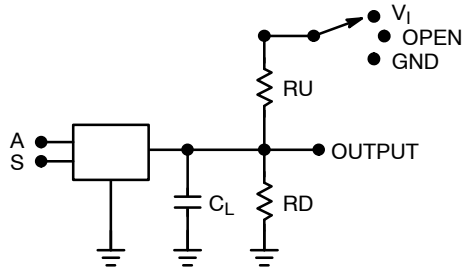
AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = +25°C			T _A = -40 to +85°C		Unit
				Min	Typ	Max	Min	Max	
t _{PLH} , t _{PHL}	Propagation Delay A to Y ₀ or Y ₁ (Figure 4, 6)	1.80 ±0.15	C _L = 15 pF, R _D = 1 MΩ, V ₁ = OPEN	–	6.3	10.1	–	10.5	ns
		2.50 ±0.20		–	3.6	5.7	–	6.0	
		3.30 ±0.30		–	2.7	4.0	–	4.3	
		5.00 ±0.50		–	2.0	3.1	–	3.3	
		3.30 ±0.30	C _L = 50 pF, R _D = 500 Ω, V ₁ = OPEN	–	3.4	4.9	–	5.4	ns
		5.00 ±0.50		–	2.5	3.9	–	4.2	
t _{PZL} , t _{PHZ}	Output Enable Time (Figure 4, 6)	1.80 ±0.15	C _L = 50 pF, R _D , R _U = 500 Ω, V ₁ = GND for t _{PZH} V ₁ = V _{IN} for t _{PZL} V _{IN} = 2 x V _{CC}	–	6.9	12.0	–	12.5	ns
		2.50 ±0.20		–	4.2	6.8	–	7.3	
		3.30 ±0.30		–	3.2	5.0	–	5.5	
		5.00 ±0.50		–	2.5	4.0	–	4.3	
	Output Disable Time (Figure 4, 6)	1.80 ±0.15	C _L = 50 pF, R _D , R _U = 500 Ω, V ₁ = GND for t _{PHZ} V ₁ = V _{IN} for t _{PLZ} V _{IN} = 2 x V _{CC}	–	6.0	10.0	–	10.5	ns
		2.50 ±0.20		–	4.0	6.8	–	7.1	
		3.30 ±0.30		–	2.9	4.9	–	5.3	
		5.00 ±0.50		–	1.8	3.5	–	3.7	
C _{IN}	Input Capacitance	0		–	2.5	–	–	–	pF
C _{OUT}	Output Capacitance	0		–	4.0	–	–	–	pF
C _{PD}	Power Dissipation Capacitance (Note 4) (Figure 5)	3.30		–	16.0	–	–	–	pF
		5.00		–	19.5	–	–	–	

4. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression:
 $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CCstatic})$.

NC7SZ18

AC Loading and Waveforms



NOTES:

5. C_L includes load and stray capacitance.
6. Input PRR = 1.0 MHz, $t_W = 500$ ns.

Figure 4. AC Test Circuit

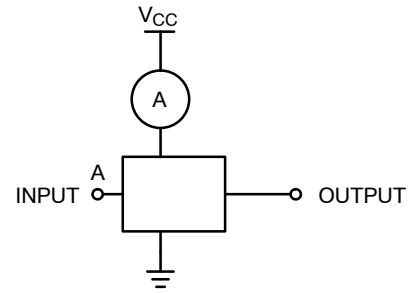


Figure 5. I_{CCD} Test Circuit

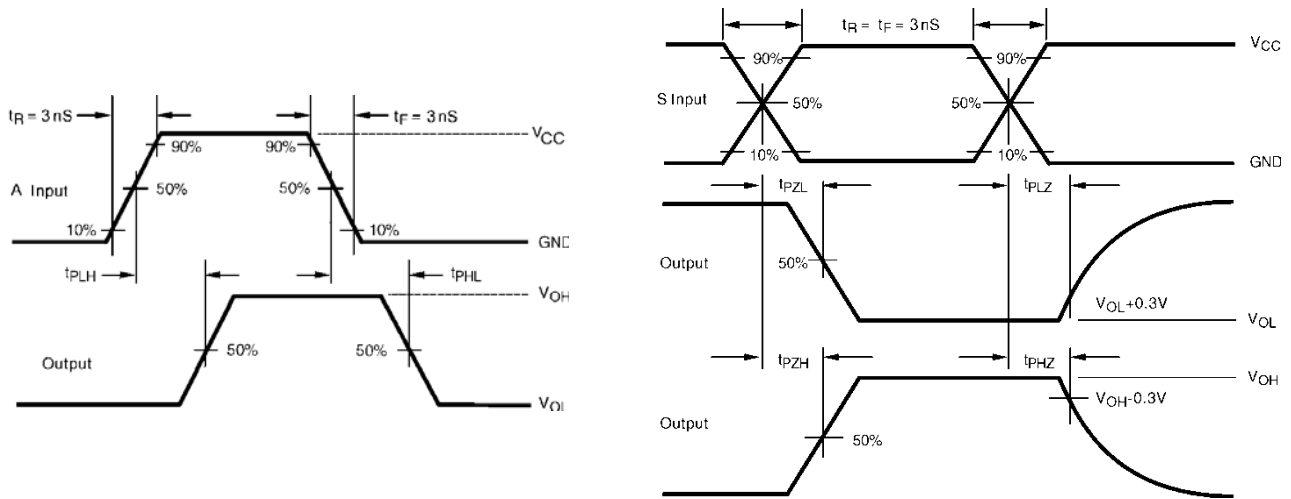


Figure 6. AC Waveforms

ORDERING INFORMATION

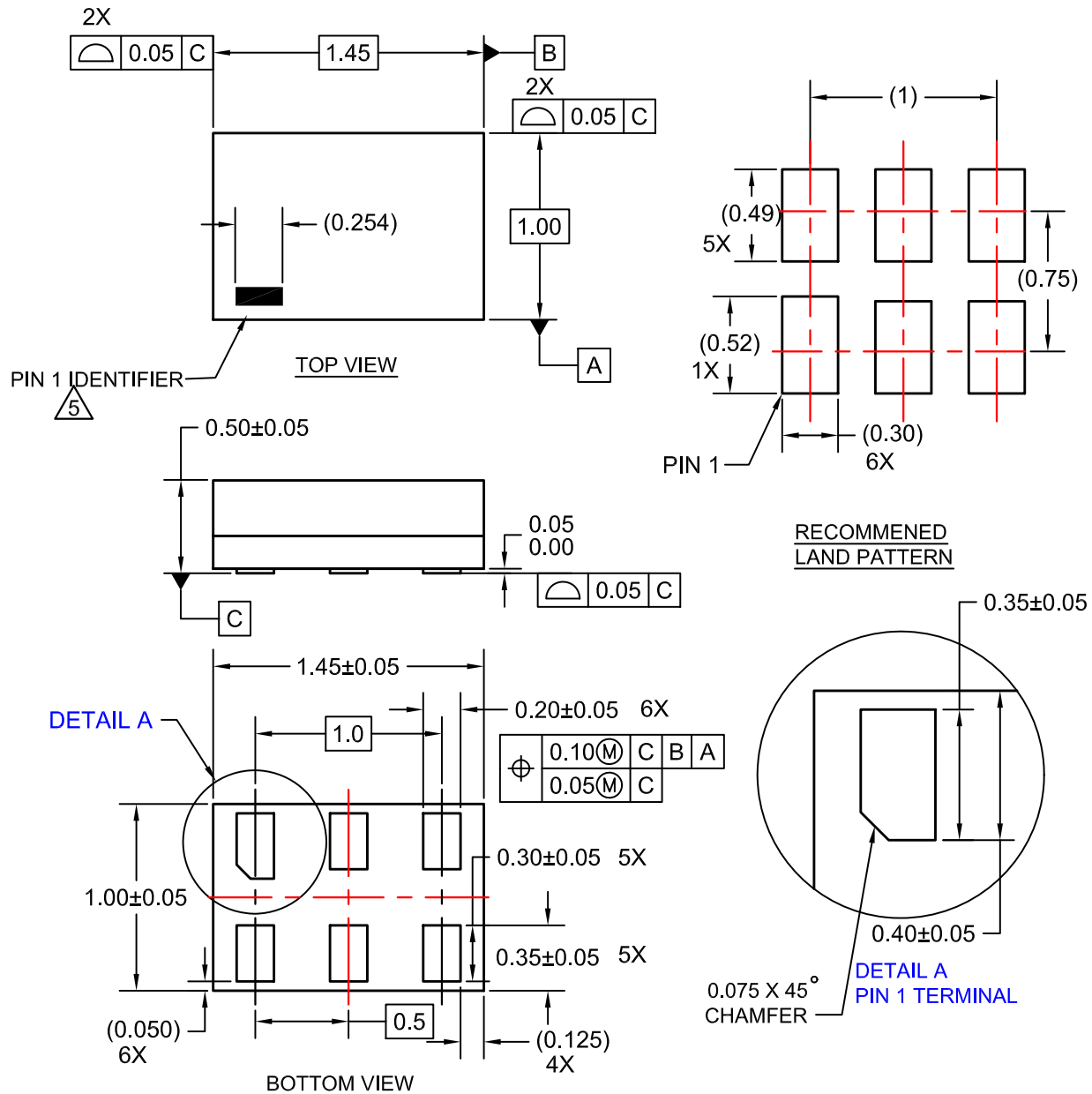
Device	Top Mark	Packages	Shipping [†]
NC7SZ18P6X	Z18	6-Lead SC70, EIAJ SC88, 1.25 mm Wide	3000 / Tape & Reel
NC7SZ18L6X	D5	6-Lead MicroPak, 1.00 mm Wide	5000 / Tape & Reel
NC7SZ18FHX	D5	6-Lead, MicroPak2, 1x1 mm Body, .35 mm Pitch	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MicroPak and MicroPak2 are trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

SIP6 1.45X1.0
CASE 127EB
ISSUE O

DATE 31 AUG 2016



NOTES:

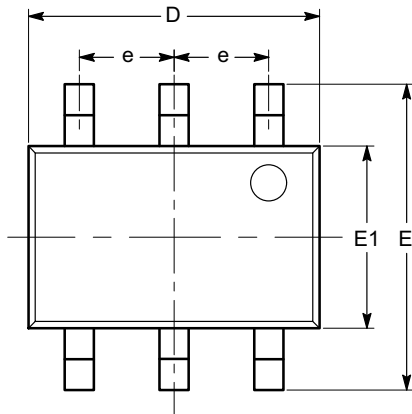
1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-2009
4. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

DOCUMENT NUMBER:	98AON13590G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	SIP6 1.45X1.0	PAGE 1 OF 1

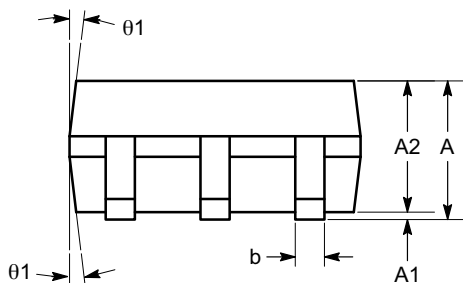
ON Semiconductor and **ON** are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

SC-88 (SC-70 6 Lead), 1.25x2
CASE 419AD-01
ISSUE A

DATE 07 JUL 2010

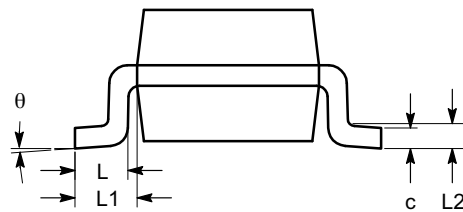


TOP VIEW



SIDE VIEW

SYMBOL	MIN	NOM	MAX
A	0.80		1.10
A1	0.00		0.10
A2	0.80		1.00
b	0.15		0.30
c	0.10		0.18
D	1.80	2.00	2.20
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
e	0.65 BSC		
L	0.26	0.36	0.46
L1	0.42 REF		
L2	0.15 BSC		
θ	0°		8°
θ1	4°		10°



END VIEW

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

DOCUMENT NUMBER:	98AON34266E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	SC-88 (SC-70 6 LEAD), 1.25X2	PAGE 1 OF 1

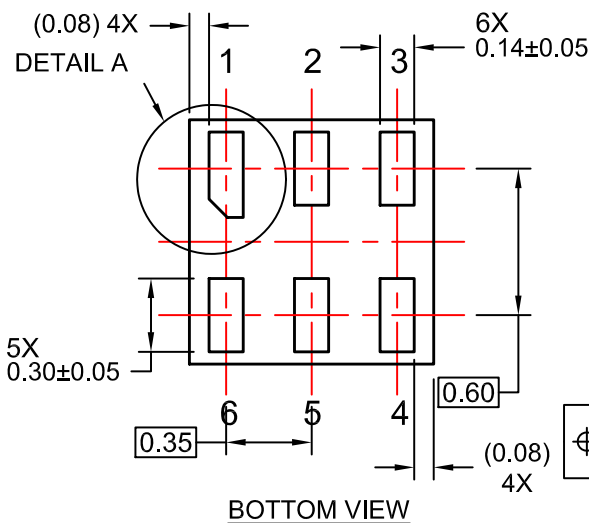
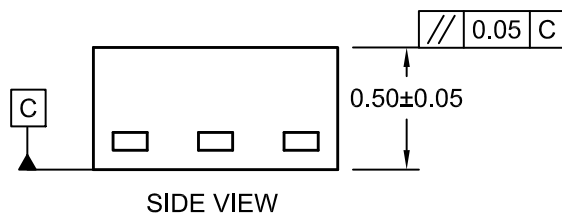
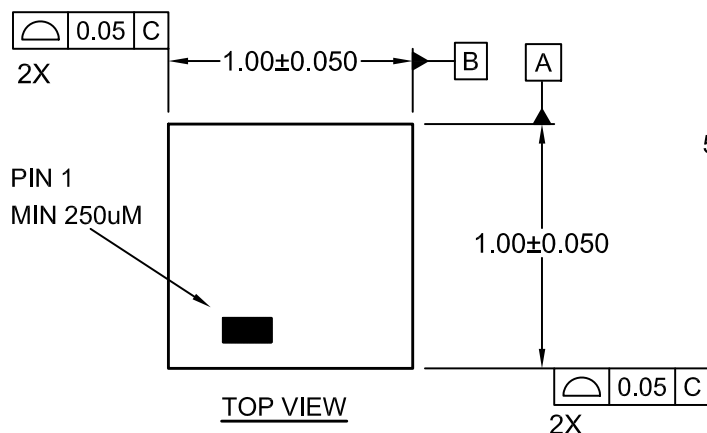
ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

UDFN6 1.0X1.0, 0.35P

CASE 517DP

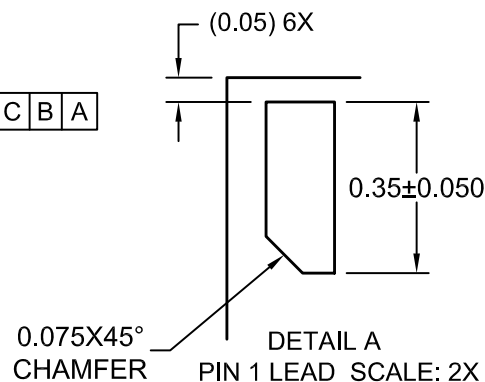
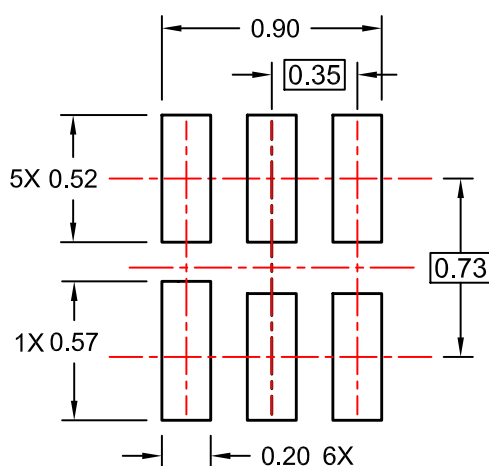
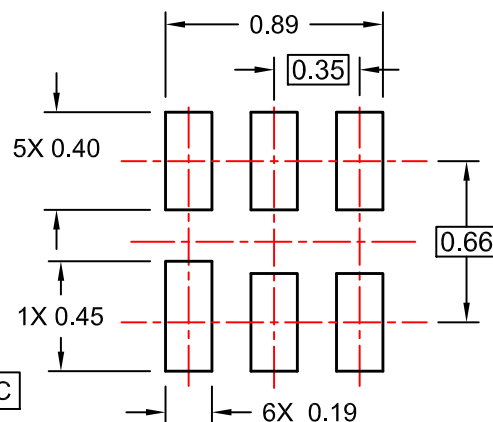
ISSUE O

DATE 31 AUG 2016



NOTES:

- A. COMPLIES TO JEDEC MO-252 STANDARD
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009



DOCUMENT NUMBER:	98AON13593G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	UDFN6 1.0X1.0, 0.35P	PAGE 1 OF 1

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT

North American Technical Support:

Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative